



**THE DATASHEET OF  
IDW15G120C5BFKSA1**



# Silicon Carbide Schottky Diode

## IDW15G120C5B

5<sup>th</sup> Generation CoolSiC™ 1200 V SiC Schottky Diode

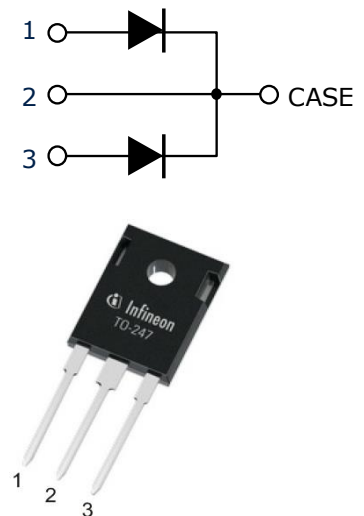
### Final Datasheet

Rev. 2.2 2021-03-01

## CoolSiC™ SiC Schottky Diode

### Features:

- Revolutionary semiconductor material - Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant



### Benefits

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: [www.infineon.com/sic](http://www.infineon.com/sic)



### Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction



### Package pin definitions

- Pin 1 – anode 1
- Pin 2 and backside – cathode
- Pin 3 – anode 2



### Key Performance and Package Parameters (leg/device)

| Type         | V <sub>DC</sub> | I <sub>F</sub> | Q <sub>C</sub> | T <sub>j,max</sub> | Marking | Package    |
|--------------|-----------------|----------------|----------------|--------------------|---------|------------|
| IDW15G120C5B | 1200V           | 7.5 / 15 A     | 41 / 82 nC     | 175°C              | D1512B5 | PG-TO247-3 |

1) J-STD20 and JESD22

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**Maximum ratings**

| Parameter  | Symbol         | Value (leg/device)             | Unit             |
|--|----------------|--------------------------------|------------------|
| Repetitive peak reverse voltage  | $V_{RRM}$      | 1200                           | V                |
| Continuous forward current for $R_{th(j-c,max)}$<br>$T_C = 154^\circ\text{C}$ , $D=1$<br>$T_C = 135^\circ\text{C}$ , $D=1$<br>$T_C = 25^\circ\text{C}$ , $D=1$ | $I_F$          | 7.5 / 15<br>11 / 23<br>24 / 49 | A                |
| Surge non-repetitive forward current, sine halfwave<br>$T_C=25^\circ\text{C}$ , $t_p=10\text{ms}$<br>$T_C=150^\circ\text{C}$ , $t_p=10\text{ms}$               | $I_{F,SM}$     | 85 / 170<br>80 / 160           | A                |
| Non-repetitive peak forward current<br>$T_C = 25^\circ\text{C}$ , $t_p=10 \mu\text{s}$   | $I_{F,max}$    | 711 / 1422                     | A                |
| $i^2t$ value<br>$T_C = 25^\circ\text{C}$ , $t_p=10 \text{ms}$<br>$T_C = 150^\circ\text{C}$ , $t_p=10 \text{ms}$  | $\int i^2 dt$  | 36 / 143<br>32 / 128           | A <sup>2</sup> s |
| Diode $dv/dt$ ruggedness<br>$V_R=0\dots960 \text{V}$   | $dv/dt$        | 150                            | V/ns             |
| Power dissipation for $R_{th(j-c,max)}$<br>$T_C = 25^\circ\text{C}$  | $P_{tot}$      | 100 / 200                      | W                |
| Operating and storage temperature  | $T_j; T_{stg}$ | -55...175                      | $^\circ\text{C}$ |
| Soldering temperature,<br>wavesoldering only allowed at leads<br>1.6mm (0.063 in.) from case for 10 s  | $T_{sold}$     | 260                            | $^\circ\text{C}$ |
| Mounting torque<br>M3 and M4 screws  | $M$            | 0.7                            | Nm               |

**Thermal Resistances**

| Parameter                                    | Symbol        | Conditions | Value (leg/device) |         |         | Unit |
|--|---------------|------------|--------------------|---------|---------|------|
|  |               |            | min.               | typ.    | max.    |      |
| <b>Characteristic</b>                        |               |            |                    |         |         |      |
| Diode thermal resistance,<br>junction – case | $R_{th(j-c)}$ |            | -                  | 1.1/0.6 | 1.5/0.8 | K/W  |
| Thermal resistance,<br>junction – ambient    | $R_{th(j-a)}$ | leaded     | -                  | -       | 62      | K/W  |

**Electrical Characteristics**
**Static Characteristic, at T<sub>j</sub>=25°C, unless otherwise specified**

| Parameter             | Symbol          | Conditions  | Value (leg/device) |         |           | Unit |
|-----------------------|-----------------|---|--------------------|---------|-----------|------|
|                       |                 |   | min.               | typ.    | max.      |      |
| DC blocking voltage   | V <sub>DC</sub> | T <sub>j</sub> = 25°C                             | 1200               | -       | -         | V    |
| Diode forward voltage | V <sub>F</sub>  | I <sub>F</sub> = 7.5/15 A, T <sub>j</sub> = 25°C  | -                  | 1.4     | 1.65      | V    |
|                       |                 | I <sub>F</sub> = 7.5/15 A, T <sub>j</sub> = 150°C | -                  | 1.7     | 2.30      |      |
| Reverse current       | I <sub>R</sub>  | V <sub>R</sub> = 1200V, T <sub>j</sub> = 25°C     |                    | 4 / 8   | 62 / 124  | μA   |
|                       |                 | V <sub>R</sub> = 1200V, T <sub>j</sub> = 150°C    |                    | 22 / 44 | 320 / 640 |      |

**Dynamic Characteristics, at T<sub>j</sub>=25°C, unless otherwise specified**

| Parameter               | Symbol         | Conditions   | Value (leg/device) |            |      | Unit |
|-------------------------|----------------|--|--------------------|------------|------|------|
|                         |                |  | min.               | typ.       | max. |      |
| Total capacitive charge | Q <sub>C</sub> | V <sub>R</sub> = 800V, T <sub>j</sub> = 150°C & 25°C<br>$Q_C = \int_0^{V_R} C(V) dV$ | -                  | 41 / 82    | -    | nC   |
| Total Capacitance       | C              | V <sub>R</sub> = 1 V, f = 1 MHz  | -                  | 525 / 1050 | -    | pF   |
|                         |                | V <sub>R</sub> = 400 V, f = 1 MHz  | -                  | 37 / 74    | -    |      |
|                         |                | V <sub>R</sub> = 800 V, f = 1 MHz  | -                  | 29 / 59    | -    |      |

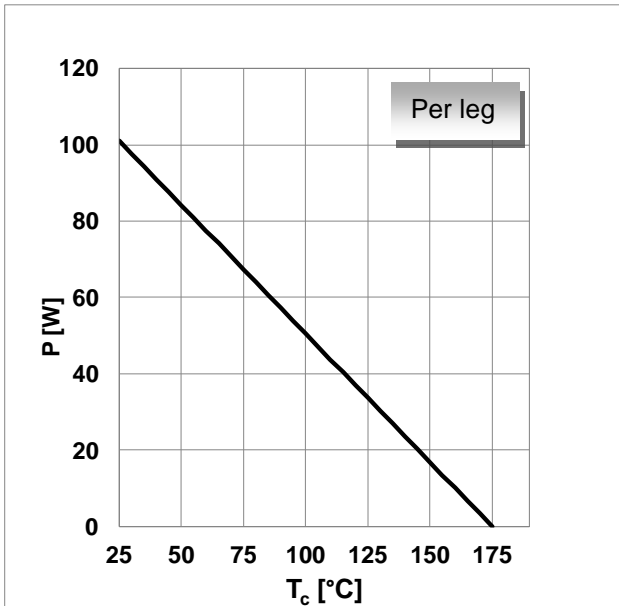


Figure 1. Power dissipation per leg as function of case temperature,  $P_{tot}=f(T_c)$ ,  $R_{th(j-c),max}$

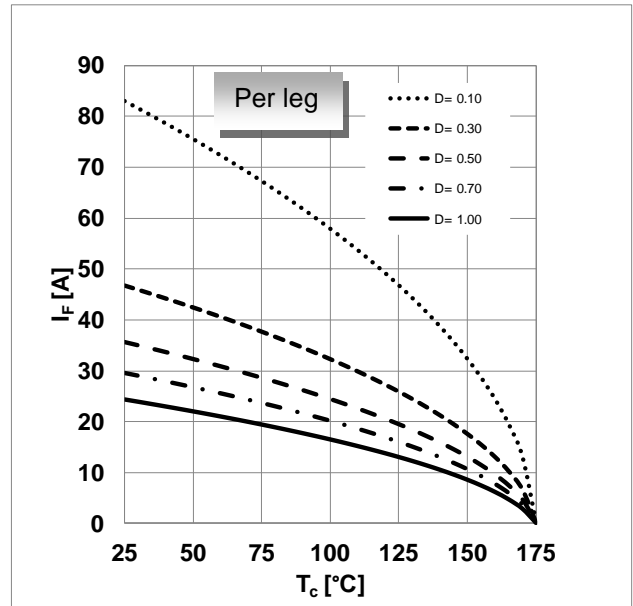


Figure 2. Diode forward current per leg as function of temperature, parameter:  $T_j \leq 175^\circ\text{C}$ ,  $R_{th(j-c),max}$ ,  $D$ =duty cycle,  $V_{th}$ ,  $R_{diff}$  @  $T_j=175^\circ\text{C}$

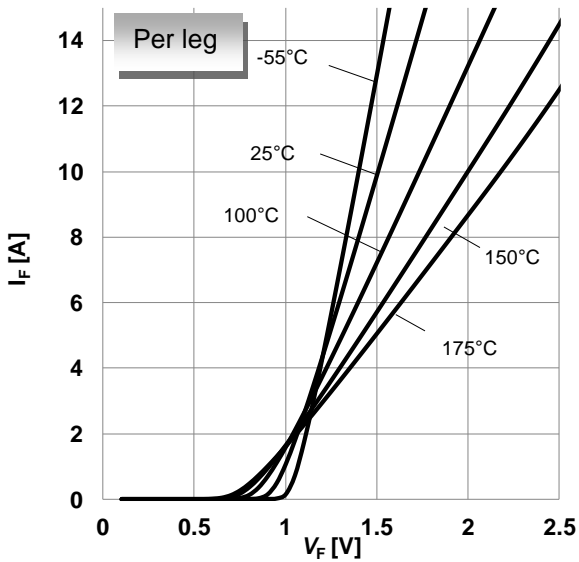


Figure 3. Typical forward characteristics per leg,  $I_F=f(V_F)$ ,  $t_p=10\ \mu\text{s}$ , parameter:  $T_j$

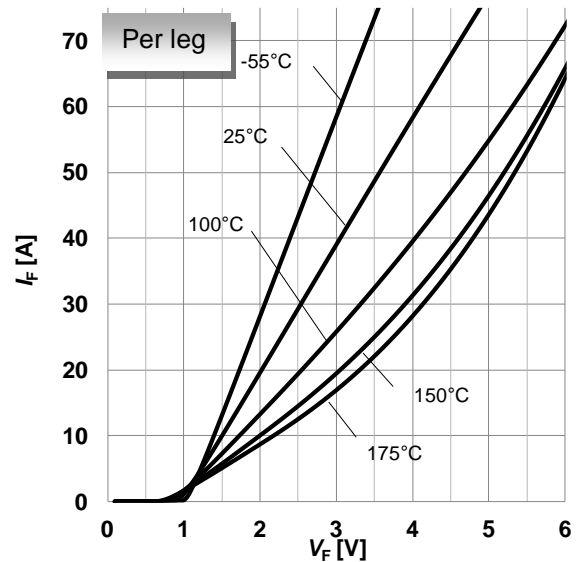


Figure 4. Typical forward characteristics in surge current per leg,  $I_F=f(V_F)$ ,  $t_p=10\ \mu\text{s}$ , parameter:  $T_j$

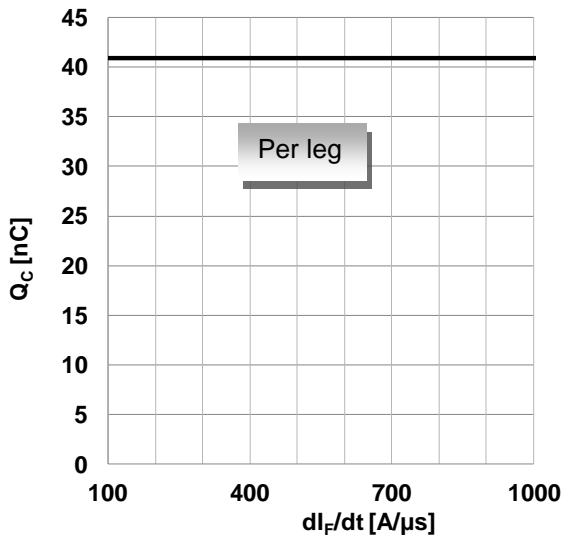


Figure 5. Typical capacitive charge per leg as function of current slope<sup>1</sup>,  $Q_c=f(di/dt)$ ,  $T_j=150^\circ\text{C}$   
 1) guaranteed by design.

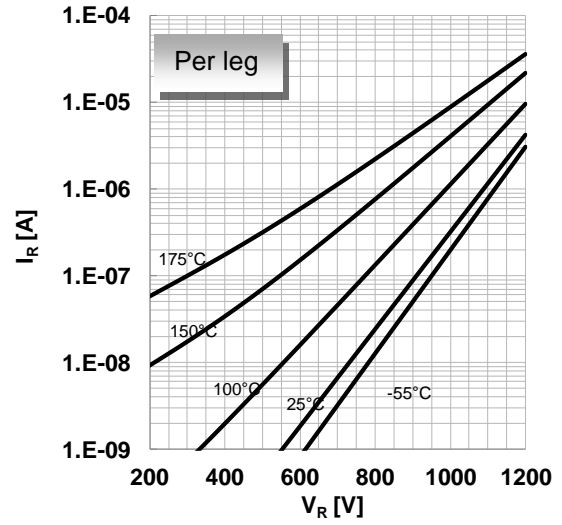


Figure 6. Typical reverse characteristics per leg,  $I_R=f(V_R)$ , parameter:  $T_j$

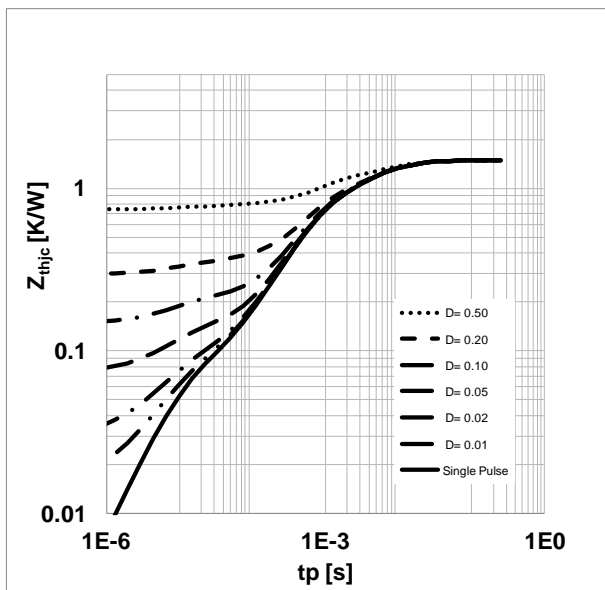


Figure 7. Max. transient thermal impedance per leg,  $Z_{th,jc}=f(tp)$ , parameter:  $D=tp/T$

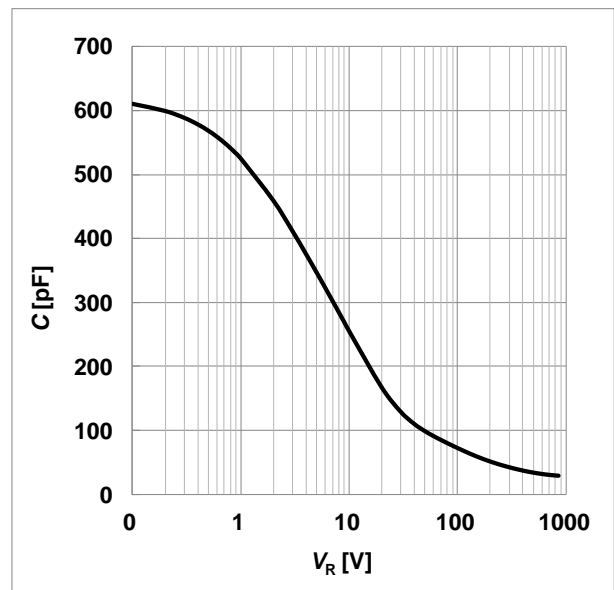


Figure 8. Typical capacitance per leg as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1\text{ MHz}$

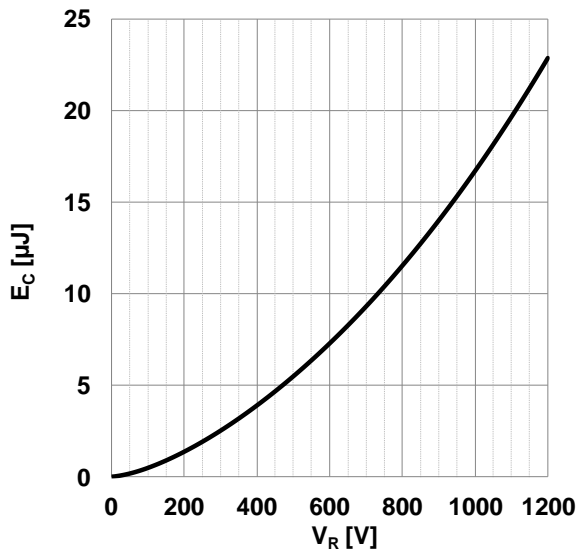
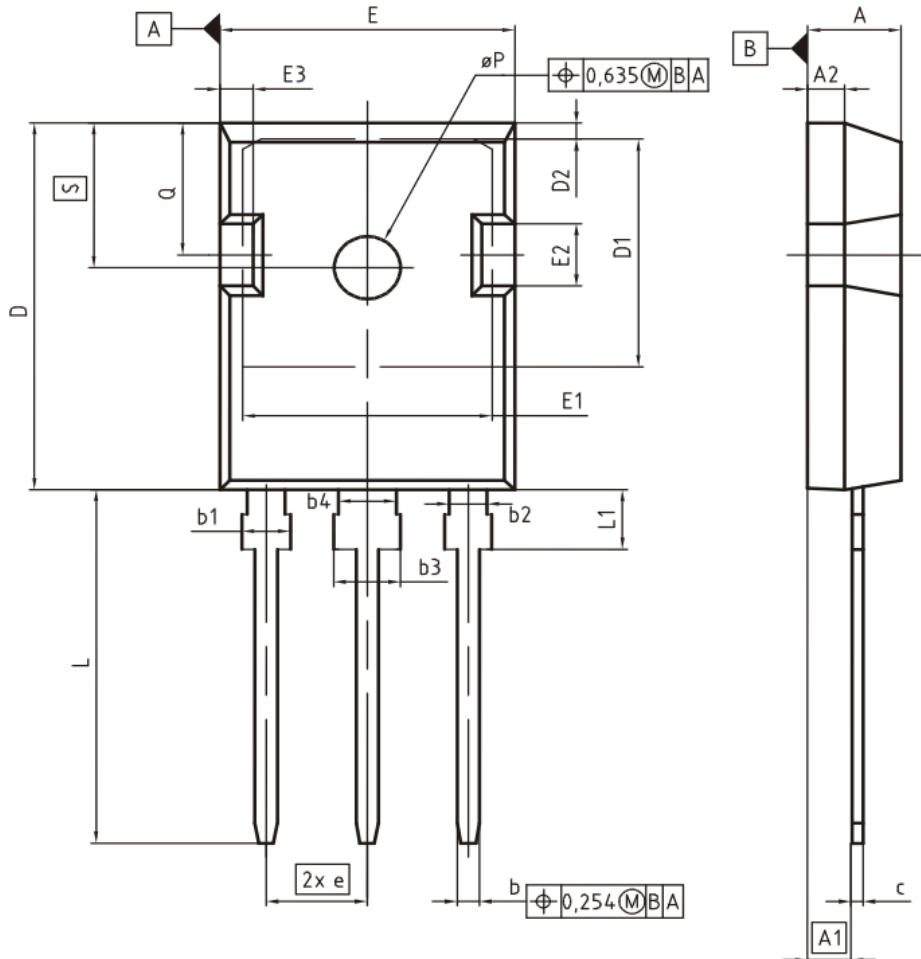


Figure 9. Typical capacitively stored energy as function of reverse voltage, per leg,  $E_C=f(V_R)$

PG-TO247-3



| DIM      | MILLIMETERS |       | INCHES      |       |
|----------|-------------|-------|-------------|-------|
|          | MIN         | MAX   | MIN         | MAX   |
| A        | 4.83        | 5.21  | 0.190       | 0.205 |
| A1       | 2.27        | 2.54  | 0.089       | 0.100 |
| A2       | 1.85        | 2.16  | 0.073       | 0.085 |
| b        | 1.07        | 1.33  | 0.042       | 0.052 |
| b1       | 1.90        | 2.41  | 0.075       | 0.095 |
| b2       | 1.90        | 2.16  | 0.075       | 0.085 |
| b3       | 2.87        | 3.38  | 0.113       | 0.133 |
| b4       | 2.87        | 3.13  | 0.113       | 0.123 |
| c        | 0.55        | 0.68  | 0.022       | 0.027 |
| D        | 20.80       | 21.10 | 0.819       | 0.831 |
| D1       | 16.25       | 17.65 | 0.640       | 0.695 |
| D2       | 0.95        | 1.35  | 0.037       | 0.053 |
| E        | 15.70       | 16.13 | 0.618       | 0.635 |
| E1       | 13.10       | 14.15 | 0.516       | 0.557 |
| E2       | 3.68        | 5.10  | 0.145       | 0.201 |
| E3       | 1.00        | 2.60  | 0.039       | 0.102 |
| e        | 5.44 (BSC)  |       | 0.214 (BSC) |       |
| N        | 3           |       | 3           |       |
| L        | 19.80       | 20.32 | 0.780       | 0.800 |
| L1       | 4.10        | 4.47  | 0.161       | 0.176 |
| $\phi P$ | 3.50        | 3.70  | 0.138       | 0.146 |
| Q        | 5.49        | 6.00  | 0.216       | 0.236 |
| S        | 6.04        | 6.30  | 0.238       | 0.248 |

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**Revision History**

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**Revision: 2021-03-01, Rev. 2.2**

Previous Revision:

| Revision | Date       | Subjects (major changes since last version) |
|----------|------------|---|
| 2.0      | 2014-06-21 | Final data sheet                            |
| 2.1      | 2017-07-21 | Editorial Changes                           |
| 2.2      | 2021-03-01 | Increased $dv/dt$ ruggedness                |

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